

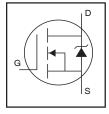
### **AUTOMOTIVE GRADE**

# AUIRLL024Z

# Features HEXFET® Power MOSFET

#### Advanced Process Technology

- Ultra Low On-Resistance
- 150°C Operating Temperature
- Fast Switching
- Repetitive Avalanche Allowed up to Timax
- Lead-Free, RoHS Compliant
- Automotive Qualified \*



V <sub>(BR)DSS</sub>	55V	
R <sub>DS(on)</sub>	typ.	<b>48m</b> $Ω$
	max.	60m $\Omega$
I <sub>D</sub>		5.0A

## Description

Specifically designed for Automotive applications, this HEXFET® Power MOSFET utilizes the latest processing techniques to achieve extremely low onresistance per silicon area. Additional features of this design are a 175°C junction operating temperature, fast switching speed and improved repetitive avalanche rating . These features combine to make this design an extremely efficient and reliable device for use in Automotive applications and a wide variety of other applications.



G	D	S
Gate	Drain	Source

#### **Absolute Maximum Ratings**

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only; and functional operation of the device at these or any other condition beyond those indicated in the specifications is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability. The thermal resistance and power dissipation ratings are measured under board mounted and still air conditions. Ambient temperature  $(T_A)$  is 25°C, unless otherwise specified.

	Parameter	Max.	Units
I <sub>D</sub> @ T <sub>A</sub> = 25°C	Continuous Drain Current, V <sub>GS</sub> @ 10V ⑦	5.0	
I <sub>D</sub> @ T <sub>A</sub> = 70°C	Continuous Drain Current, V <sub>GS</sub> @ 10V ⑦	4.0	Α
I <sub>DM</sub>	Pulsed Drain Current ①	40	
P <sub>D</sub> @T <sub>A</sub> = 25°C	Power Dissipation ⑦	2.8	
P <sub>D</sub> @T <sub>A</sub> = 25°C	Power Dissipation ®	1.0	W
	Linear Derating Factor ②	0.02	W/°C
$V_{GS}$	Gate-to-Source Voltage	± 16	V
E <sub>AS</sub>	Single Pulse Avalanche Energy (Thermally Limited) ②	21	mJ
E <sub>AS</sub> (tested )	Single Pulse Avalanche Energy Tested Value ®	38	
I <sub>AR</sub>	Avalanche Current ①	See Fig.12a, 12b, 15, 16	Α
E <sub>AR</sub>	Repetitive Avalanche Energy ©		mJ
$T_{J}$	Operating Junction and	-55 to + 150	
T <sub>STG</sub>	Storage Temperature Range		°C

#### Thermal Resistance

	Parameter	Тур.	Max.	Units
$R_{\theta JA}$	Junction-to-Ambient (PCB mount, steady state) ♡		45	°C/W
$R_{\theta JA}$	Junction-to-Ambient (PCB mount, steady state) ®		120	

HEXFET® is a registered trademark of International Rectifier.

<sup>\*</sup>Qualification standards can be found at http://www.irf.com/

## Static Electrical Characteristics @ T<sub>J</sub> = 25°C (unless otherwise specified)

	Parameter	Min.	Тур.	Max.	Units	Conditions
V <sub>(BR)DSS</sub>	Drain-to-Source Breakdown Voltage	55			V	$V_{GS} = 0V, I_D = 250\mu A$
$\Delta V_{(BR)DSS}/\Delta T_{J}$	Breakdown Voltage Temp. Coefficient		0.049		V/°C	Reference to 25°C, I <sub>D</sub> = 1mA
			48	60		V <sub>GS</sub> = 10V, I <sub>D</sub> = 3.0A ③
R <sub>DS(on)</sub>	Static Drain-to-Source On-Resistance			80	mΩ	$V_{GS} = 5.0V, I_D = 3.0A$ ③
				100		$V_{GS} = 4.5V, I_D = 3.0A$ ③
$V_{GS(th)}$	Gate Threshold Voltage	1.0		3.0	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$
gfs	Forward Transconductance	7.5			S	$V_{DS} = 25V, I_D = 3.0A$
I <sub>DSS</sub>	Drain-to-Source Leakage Current			20	μA	$V_{DS} = 55V$ , $V_{GS} = 0V$
				250		$V_{DS} = 55V, V_{GS} = 0V, T_{J} = 125^{\circ}C$
I <sub>GSS</sub>	Gate-to-Source Forward Leakage			200	nA	V <sub>GS</sub> = 16V
	Gate-to-Source Reverse Leakage			-200		V <sub>GS</sub> = -16V

## Dynamic Electrical Characteristics @ T<sub>J</sub> = 25°C (unless otherwise specified)

	Parameter	Min.	Тур.	Max.	Units	Conditions
$Q_g$	Total Gate Charge		7.0	11		$I_D = 3.0A$
$Q_{gs}$	Gate-to-Source Charge		1.5		nC	$V_{DS} = 44V$
$Q_{gd}$	Gate-to-Drain ("Miller") Charge		4.0			V <sub>GS</sub> = 5.0V ③
t <sub>d(on)</sub>	Turn-On Delay Time		8.6			$V_{DD} = 28V$
t <sub>r</sub>	Rise Time		33		ns	$I_{D} = 3.0A$
t <sub>d(off)</sub>	Turn-Off Delay Time		20			$R_G = 56 \Omega$
t <sub>f</sub>	Fall Time		15			V <sub>GS</sub> = 5.0V ③
C <sub>iss</sub>	Input Capacitance		380			$V_{GS} = 0V$
C <sub>oss</sub>	Output Capacitance		66			$V_{DS} = 25V$
C <sub>rss</sub>	Reverse Transfer Capacitance		36		pF	f = 1.0MHz
C <sub>oss</sub>	Output Capacitance		220			$V_{GS} = 0V, V_{DS} = 1.0V, f = 1.0MHz$
C <sub>oss</sub>	Output Capacitance		53			$V_{GS} = 0V, V_{DS} = 44V, f = 1.0MHz$
C <sub>oss</sub> eff.	Effective Output Capacitance		93			$V_{GS} = 0V$ , $V_{DS} = 0V$ to 44V $\textcircled{4}$

#### **Diode Characteristics**

	Parameter	Min.	Тур.	Max.	Units	Conditions
I <sub>S</sub>	Continuous Source Current			5.0		MOSFET symbol
	(Body Diode)				Α	showing the
I <sub>SM</sub>	Pulsed Source Current			40		integral reverse
	(Body Diode) ①					p-n junction diode.
$V_{SD}$	Diode Forward Voltage			1.3	V	$T_J = 25^{\circ}C$ , $I_S = 3.0A$ , $V_{GS} = 0V$ ③
t <sub>rr</sub>	Reverse Recovery Time		15	23	ns	$T_J = 25^{\circ}C$ , $I_F = 3.0A$ , $V_{DD} = 28V$
Q <sub>rr</sub>	Reverse Recovery Charge		9.1	14	nC	di/dt = 100A/µs ③
t <sub>on</sub>	Forward Turn-On Time	Intrinsi	c turn-or	time is	negligible	e (turn-on is dominated by LS+LD)

#### Notes:

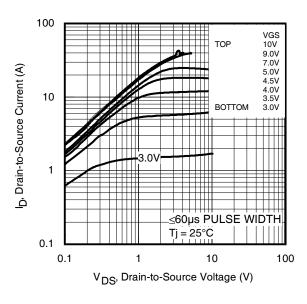
- ① Repetitive rating; pulse width limited by max. junction temperature. (See fig. 11).
- ② Limited by  $T_{Jmax}$ , starting  $T_J = 25^{\circ}C$ , L = 4.8 mH  $R_G = 25\Omega$ ,  $I_{AS} = 3.0A$ ,  $V_{GS} = 10V$ . Part not recommended for use above this value.
- Coss eff. is a fixed capacitance that gives the same charging time as Coss while VDS is rising from 0 to 80% VDSS.
- ® This value determined from sample failure population, starting  $T_J$  = 25°C, L = 4.8mH,  $R_G$  = 25Ω,  $I_{AS}$  = 3.0A,  $V_{GS}$  =10V.
- When mounted on 1 inch square copper board.
- When mounted on FR-4 board using minimum recommended footprint.

# Qualification Information<sup>†</sup>

			Automotive				
		(per AEC-Q101)					
Qualification Level		Comments: This part number(s) passed Automo qualification. IR's Industrial and Consumer qualificat level is granted by extension of the higher Automo level.					
Moisture Sensitivity	Level	SOT-223 MSL1					
	Machine Model		Class M1B (+/- 100V) <sup>††</sup>				
		AEC-Q101-002					
	Human Body Model		Class H0 (+/- 250V) <sup>††</sup>				
ESD		AEC-Q101-001					
Charged Device Model		Class C5 (+/- 1125V) <sup>††</sup>					
		AEC-Q101-005					
RoHS Compliant		Yes					

<sup>†</sup> Qualification standards can be found at International Rectifier's web site: http://www.irf.com/

<sup>††</sup> Highest passing voltage.



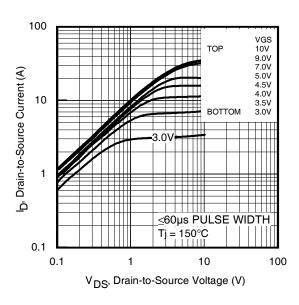
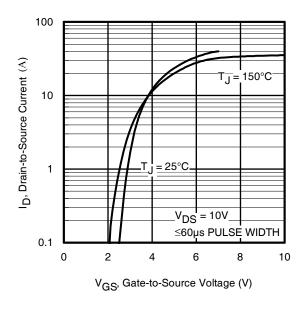


Fig 1. Typical Output Characteristics

Fig 2. Typical Output Characteristics



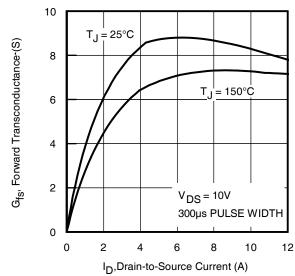


Fig 3. Typical Transfer Characteristics

Fig 4. Typical Forward Transconductance vs. Drain Current

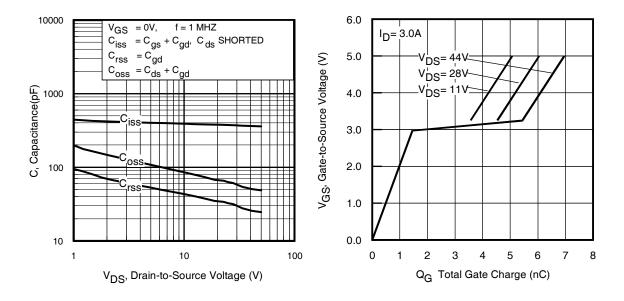


Fig 5. Typical Capacitance vs. Drain-to-Source Voltage

Fig 6. Typical Gate Charge vs. Gate-to-Source Voltage

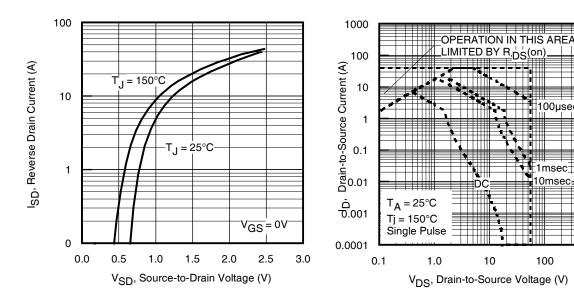
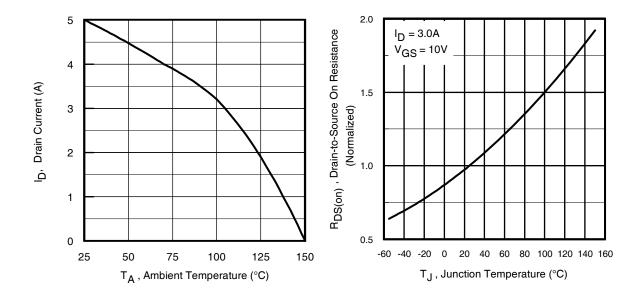


Fig 7. Typical Source-Drain Diode Forward Voltage

Fig 8. Maximum Safe Operating Area

1000.0

100



**Fig 9.** Maximum Drain Current vs. Ambient Temperature

**Fig 10.** Normalized On-Resistance vs. Temperature

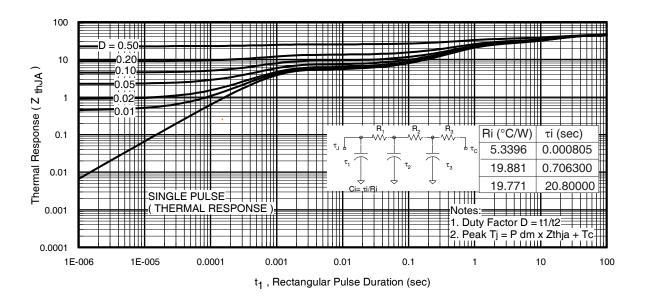


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Ambient

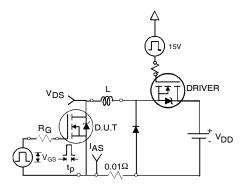


Fig 12a. Unclamped Inductive Test Circuit

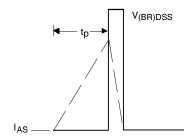


Fig 12b. Unclamped Inductive Waveforms

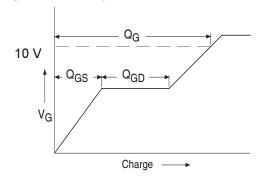
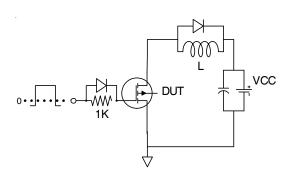


Fig 13a. Basic Gate Charge Waveform



100  $\mathsf{E}_{\mathsf{AS}}$  , Single Pulse Avalanche Energy (mJ) Ь TOP 3.0A 80 0.80A BOTTOM 0.69A 60 40 20 0 25 50 75 100 125 150 Starting  $T_J$ , Junction Temperature (°C)

**Fig 12c.** Maximum Avalanche Energy vs. Drain Current

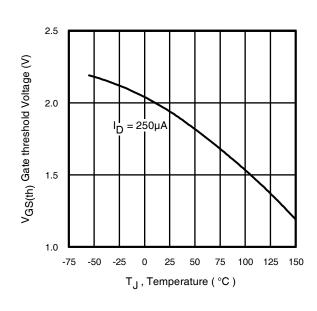


Fig 14. Threshold Voltage vs. Temperature

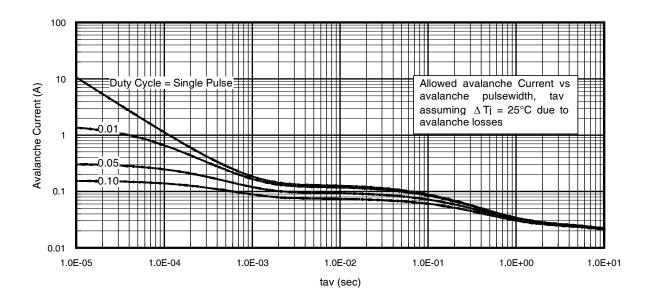
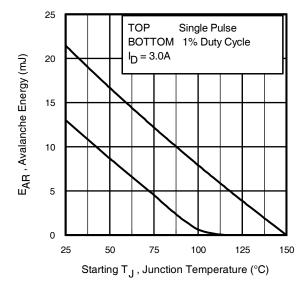


Fig 15. Typical Avalanche Current vs. Pulsewidth



D = Duty cycle in avalanche =  $t_{av} \cdot f$  $Z_{thJC}(D, t_{av})$  = Transient thermal resistance, see figure 11)

$$\begin{split} P_{D~(ave)} &= 1/2~(~1.3 \cdot \text{BV} \cdot \text{I}_{av}) = \triangle \text{T/}~Z_{thJC} \\ I_{av} &= 2\triangle \text{T/}~[1.3 \cdot \text{BV} \cdot \text{Z}_{th}] \end{split}$$
 $E_{AS (AR)} = P_{D (ave)} \cdot t_{av}$ 

vs. Temperature

8

Notes on Repetitive Avalanche Curves, Figures 15, 16: (For further info, see AN-1005 at www.irf.com)

- 1. Avalanche failures assumption:
  - Purely a thermal phenomenon and failure occurs at a temperature far in excess of  $T_{imax}$ . This is validated for every part type.
- 2. Safe operation in Avalanche is allowed as long  $asT_{jmax}$  is
- not exceeded. 3. Equation below based on circuit and waveforms shown in
- Figures 12a, 12b. 4. P<sub>D (ave)</sub> = Average power dissipation per single avalanche pulse.
- 5. BV = Rated breakdown voltage (1.3 factor accounts for voltage increase during avalanche).

7.  $\Delta T$  = Allowable rise in junction temperature, not to exceed T<sub>imax</sub> (assumed as 25°C in Figure 15, 16).

- 6.  $I_{av}$  = Allowable avalanche current.
  - $t_{av}$  = Average time in avalanche.

Fig 16. Maximum Avalanche Energy

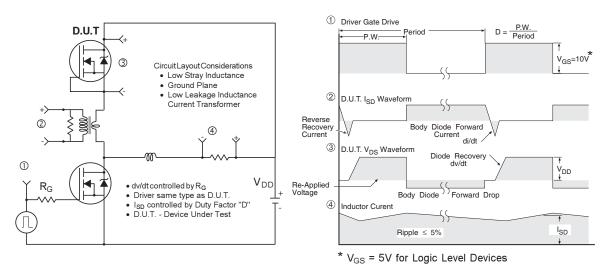


Fig 17. Peak Diode Recovery dv/dt Test Circuit for N-Channel HEXFET® Power MOSFETs

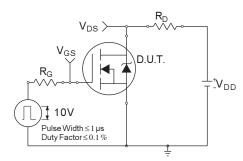


Fig 18a. Switching Time Test Circuit

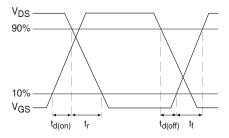
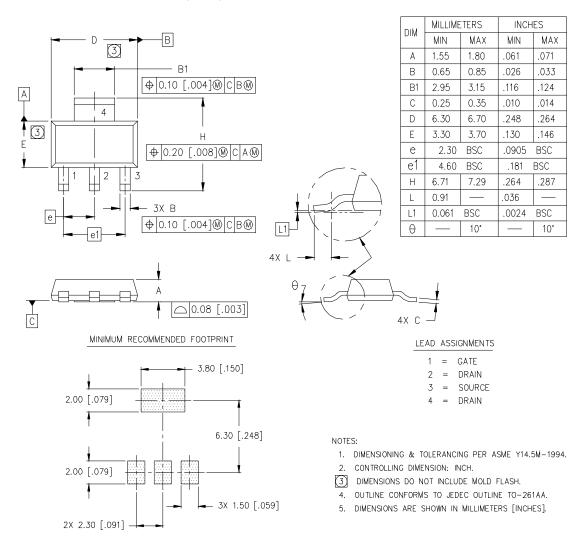


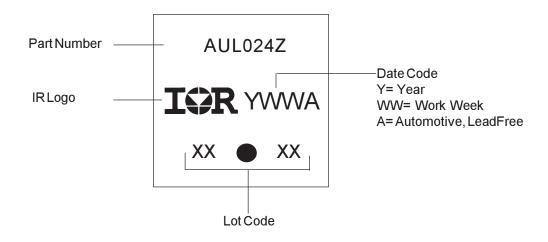
Fig 18b. Switching Time Waveforms

## SOT-223 (TO-261AA) Package Outline

Dimensions are shown in milimeters (inches)



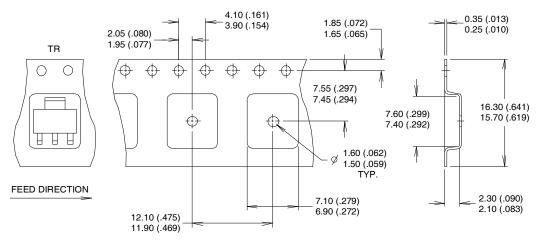
## SOT-223 (TO-261AA) Part Marking Information



Note: For the most current drawing please refer to IR website at http://www.irf.com/package/

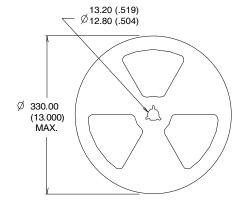
# SOT-223 (TO-261AA) Tape & Reel Information

Dimensions are shown in milimeters (inches)



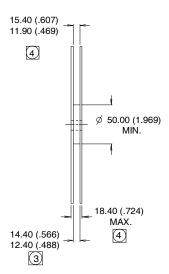
#### NOTES:

- 1. CONTROLLING DIMENSION: MILLIMETER.
- 2. OUTLINE CONFORMS TO EIA-481 & EIA-541.
- 3. EACH Ø330.00 (13.00) REEL CONTAINS 2,500 DEVICES.



#### NOTES:

- 1. OUTLINE COMFORMS TO EIA-418-1.
- 2. CONTROLLING DIMENSION: MILLIMETER...
- DIMENSION MEASURED @ HUB.
- INCLUDES FLANGE DISTORTION @ OUTER EDGE.



# Ordering Information

Base part	Package Type	Standard Pack		Complete Part Number
		Form	Quantity	
AUIRLL024Z	SOT-223	Tube	95	AUIRLL024Z
		Tape and Reel	2500	AUIRLL024ZTR

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